

Quarterly Reliability Monitoring Results

Quarters: Q1/2022 to Q4/2023

Based on structural similarity

Supplier Nexperia B.V. Name of Laboratory Assembly reliability labs Based on AEC-Q101 Test		User Part Number BZX8450-C3V9-Q Part Description											
									Nexperia DHAM Zener				
									SMD package				
		Test Conditions	Duration	# Lots	# Quantity	# Rejects							
			TEST										
			Pre- and Post-Stress										
# E1	Electrical Test	Tamb = 25 °C	N/A	see below	all parts	see below							
		JESD22-A113											
		Bake Tamb = 125 °C	24 hours										
	PC	Soak Tamb = 85 °C, RH = 85%	168 hours										
# A1	Preconditioning	Reflow soldering	3 cycles	1514	64430	0							
		MIL-STD-750-1											
	HTRB	M1038 Method A											
		Tj = Tjmax, VR = 80 % of rated reverse				_							
# B1	Bias	voltage	1000 hours	250	11400	0							
		MIL-STD-750-1											
		M1038 Method B											
	SSOP	Tj = Tjmax, Iz = 100% of max. datasheet				_							
# B1b	Steady State Operational	reverse current	1000 hours	44	1920	0							
		JECD22 4404											
	TC	JESD22-A104	1000	244	1 1000								
# A4	Temperature Cycling	-65 °C to Tjmax, not to exceed 150°C	1000 cycles	311	14080	0							
	HUACT	JECD22 A110											
# A3 or	UHAST Unbiased HAST	JESD22-A118 Tamb = 130 °C, RH = 85 %											
# A3 01	Olibiaseu HAST	· · · · · · · · · · · · · · · · · · ·	-96 hours	311	14080	0							
	AC	JESD22-A102 Tamb = 121 °C, RH = 100 %											
# A3 alt	Autoclave	Pressure = 205 kPa (29.7 psia)											
# A3 ait	Adtociave	11e33dre = 203 ki d (23.7 p3id)											
	H3TRB	JESD22-A101											
	High Humidity High	Tamb = 85 °C, RH = 85%, VR = 80 % of											
# A2 alt		rated reverse voltage ^[1]	1000 hours	311	14080	0							
, AL die		MIL-STD-750 Method 1037			000	-							
	IOL	ton = toff, devices powered to insure ΔT_j =											
# A5	Intermittent Operating Life		1000 hours	312	14120	0							
			_300		120	-							
	RSH	JESD22-A111											
# C8	Resistance to Solder Heat	260 °C ± 5 °C	10 s	269	8070	0							
50	SD		_,,,	_05	-0.0	-							
# C10	Solderability	J-STD-002		19	6660	0							

^[1] The maximum applied voltage is limited by test chamber set up and does not exceed 115V.

Calculation of FIT and MTTF

Test considered for FIT calculation: High Temperature Reverse Bias (HTRB, Test #B1) Confidence level 60%, derated to 55 °C, activation energy 0.7 eV, test time 168 to 1000 hours

Wafer Fab	Technology	Quantity	Rejects	Failure Rate (FIT)	MTTF (hrs)
Nexperia					
DHAM	Zener	11400	0	0,37	2,68E+09

© 2024 Nexperia B.V.

All information hereunder is per Nexperia's best knowledge. This document does not provide for any representation or warranty express or implied by Nexperia. In case Nexperia has tested the product, this documentation reflects the outcome of the analysis of the actually tested parts only.

nexperia.com